Gallium Nitride 50V, 650W, 3.3-3.6GHz RF Power Transistor

Description

The STCV36650CY4V is a 650-watt, internally matched GaN HEMT, designed for 5G cellular applications with frequencies from 3.3-3.6GHz, **enabled by wide band VBW capability to support IBW up to 300MHz.**.

It can be configured as asymmetrical Doherty for 4G or 5G application, delivering 80-100W average power, according to normal 8 to 9dB back off.

There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

• Typical Doherty Pulsed CW and 1C W--CDMA Characterization Performance:

VDD = 50 Vdc, IDQA = 260 mA, VGSB = -6.2Vdc,

Frog	Pulse CW Signal ⁽¹⁾			P _{avg} =49.5dBm WCDMA Signal ⁽²⁾			
Freq (GHz)	P1-Gain (dB)	P3 (dBm)	P3 (W)	Gp (dB)	η ₀ (%)	ACPR₅м (dBc)	
3.3	12.86	58.60	724	12.07	47.50	-31.01	
3.4	12.65	58.72	745	12.28	46.35	-32.85	
3.5	12.79	58.64	732	12.28	45.16	-35.39	
3.6	12.33	58.38	689	12.12	44.90	-31.69	

1C WCDMA; Signal PAR = 10 dB @ 0.01% Probability on CCDF.

Applications

- Asymmetrical Doherty amplifier within N77/78 5G band
- S band power amplifier

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

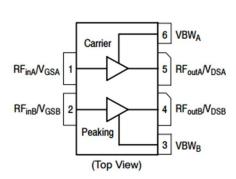
Turning the device ON

- 1. Set VGS to the pinch—off (VP) voltage, typically –5 V $\,$
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically –5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Figure 1: Pin Connection definition



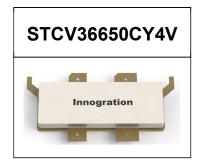


Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain—Source Voltage	V _{DSS}	+200	Vdc
Gate—Source Voltage	V _{GS}	-8 to +0.5	Vdc
Operating Voltage	V _{DD}	55	Vdc
Maximum gate current	lgs	85	mA
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA	Balo	0.8	°C /W
T _c = 85°C, Pout=80W, 3.8GHz Doherty application board	Rejc	0.8	

Table 3. Electrical Characteristics (TA = 25°C unless otherwise noted)

DC Characteristics (main path, measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=34mA	V _{DSS}		200		V
Gate Threshold Voltage	VDS =10V, ID = 34mA		-4		-2	V
Gate Quiescent Voltage	VDS =50V, IDS=280mA, Measured in Functional Test	$V_{GS(Q)}$		-3.2		V

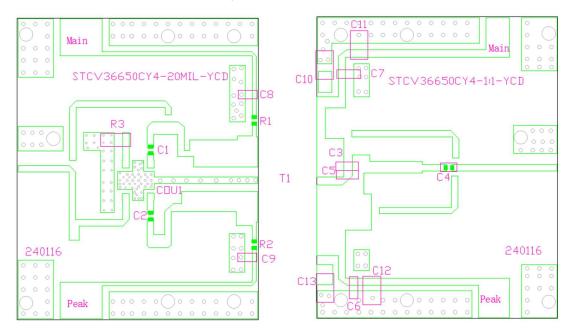
DC Characteristics (peak path, measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=51mA	V _{DSS}		200		V
Gate Threshold Voltage	VDS =10V, ID = 51mA	V _{GS(th)}	-4		-2	V
Gate Quiescent Voltage	VDS =50V, IDS=420mA Measured in Functional Test	V _{GS(Q)}		-3.2		V

Ruggedness Characteristics

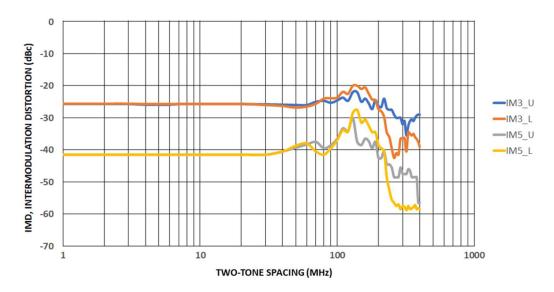
Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	3.6GHz, Pout=80W WCDMA 1 Carrier in Doherty circuit All phase, No device damages	VSWR		10:1		

Figure 3: Picture of application board Doherty circuit for 3.3-3.6GHz



Part	Quantity	Description	Part Number	Manufacture
C1,C2,C4,C6,	7	8.2pFHigh Q	251SHS8R2BSE	TEMEX
C7,C8,C9		Capacitor		
C3,C5	2	1.0pFHigh Q	251SHS1R0BSE	TEMEX
		Capacitor		
C10,C11,C12,C13	4	10uF MLCC	RS80R2A106M	MARUWA
R1,R2	2	10 Ω Power Resistor	ESR03EZPF10R0	ROHM
R3	1	51 Ω Power Resistor	RFR50-20CT0421B	YT
COUT1	1	3 dB Bridge	XC3500P-03S	ANAREN
T1	1	650W GaN	STCV36650CY4V	Innogration
		Dual Transistor		

Vdd=50V, Pout=48.5dBm, Center Frequency=3.6GHz



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Figure 5: Efficiency and power gain as function of Pout

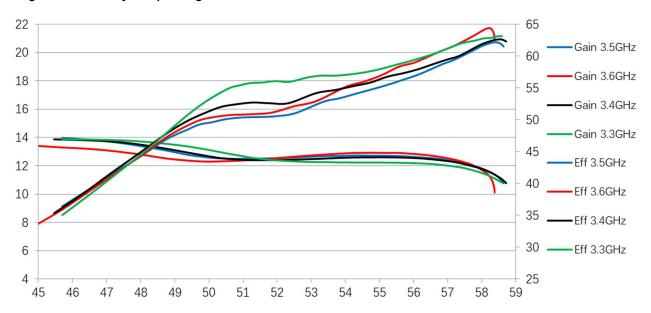
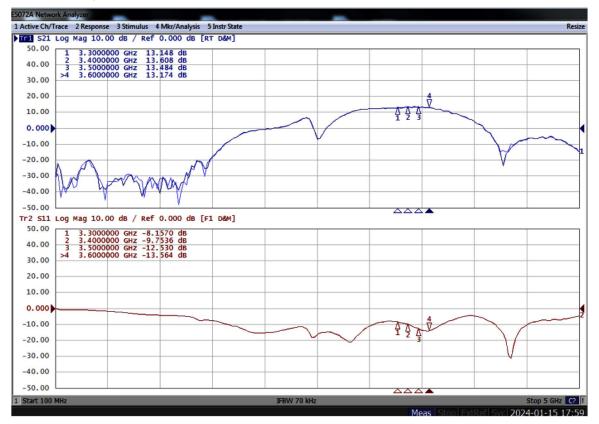


Figure 6: Network analyzer output, S11 and S21



1.54±0.13

Earless Flanged Ceramic Package; 6 leads- CY4V

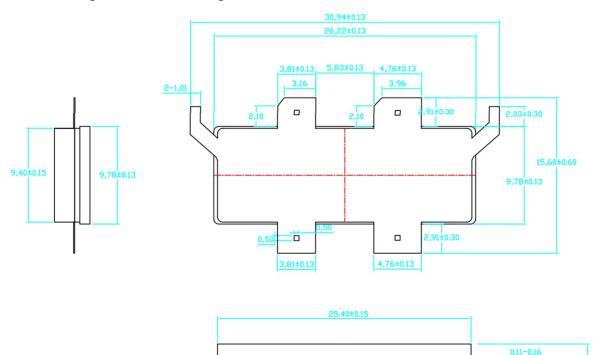




Table 4. Document revision history

Date	Revision	Datasheet Status
2024/1/17	V1.0	Preliminary Datasheet Creation

Application data based on LWH-24-03

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